

## SSD20P15-295D-VB Datasheet

### P-Channel 150 V (D-S) MOSFET

#### PRODUCT SUMMARY

$V_{DS}$ (V)	$R_{DS(on)}$ ( $\Omega$ )	$I_D$ (A)	$Q_g$ (Typ.)
- 150	0.270 at $V_{GS} = - 10$ V	- 10	11.7
	0.280 at $V_{GS} = - 4.5$ V	- 8	

#### FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Trench Power MOSFET
- 100 %  $R_g$  and UIS Tested
- Compliant to RoHS Directive 2002/95/EC



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

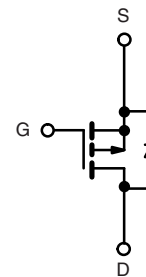
#### APPLICATIONS

- Power Switch
- DC/DC Converters

TO-252



Top View



P-Channel MOSFET

#### ABSOLUTE MAXIMUM RATINGS $T_C = 25^\circ\text{C}$ , unless otherwise noted

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DS}$	- 150	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	
Continuous Drain Current ( $T_J = 150^\circ\text{C}$ )	$I_D$	- 10	A
		- 8	
Pulsed Drain Current	$I_{DM}$	- 30	
Avalanche Current	$I_{AS}$	- 18	
Single Avalanche Energy <sup>a</sup>	$E_{AS}$	16.2	mJ
Maximum Power Dissipation <sup>a</sup>	$P_D$	32.1 <sup>b</sup>	W
		2.5	
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	- 55 to 150	$^\circ\text{C}$

#### THERMAL RESISTANCE RATINGS

Parameter	Symbol	Limit	Unit
Junction-to-Ambient (PCB Mount) <sup>c</sup>	$R_{thJA}$	50	$^\circ\text{C/W}$
Junction-to-Case (Drain)	$R_{thJC}$	3.9	

Notes:

a. Duty cycle  $\leq 1\%$ .

b. See SOA curve for voltage derating.

c. When Mounted on 1" square PCB (FR-4 material).

SPECIFICATIONS $T_J = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted						
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{DS} = 0\text{ V}$ , $I_D = -250\text{ }\mu\text{A}$	-150			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = -250\text{ }\mu\text{A}$	-1		-2.5	
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0\text{ V}$ , $V_{GS} = \pm 20\text{ V}$			$\pm 250$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -120\text{ V}$ , $V_{GS} = 0\text{ V}$			-1	$\mu\text{A}$
		$V_{DS} = -120\text{ V}$ , $V_{GS} = 0\text{ V}$ , $T_J = 125\text{ }^{\circ}\text{C}$			-50	
		$V_{DS} = -120\text{ V}$ , $V_{GS} = 0\text{ V}$ , $T_J = 150\text{ }^{\circ}\text{C}$			-250	
On-State Drain Current <sup>a</sup>	$I_{D(on)}$	$V_{DS} \leq -10\text{ V}$ , $V_{GS} = -10\text{ V}$	-15			A
Drain-Source On-State Resistance <sup>a</sup>	$R_{DS(on)}$	$V_{GS} = -10\text{ V}$ , $I_D = -3.6\text{ A}$		0.270		$\Omega$
		$V_{GS} = -4.5\text{ V}$ , $I_D = -3.4\text{ A}$		0.280		
Forward Transconductance <sup>a</sup>	$g_{fs}$	$V_{DS} = -15\text{ V}$ , $I_D = -3.6\text{ A}$		12		S
Dynamic <sup>b</sup>						
Input Capacitance	$C_{iss}$	$V_{GS} = 0\text{ V}$ , $V_{DS} = -75\text{ V}$ , $f = 1\text{ MHz}$		1000		pF
Output Capacitance	$C_{oss}$			65		
Reverse Transfer Capacitance	$C_{rss}$			41		
Total Gate Charge <sup>c</sup>	$Q_g$	$V_{DS} = -75\text{ V}$ , $V_{GS} = -10\text{ V}$ , $I_D = -3.6\text{ A}$		23.2	34.8	nC
		$V_{DS} = -75\text{ V}$ , $V_{GS} = -4.5\text{ V}$ , $I_D = -3.6\text{ A}$		11.7	17.6	
$Q_{gs}$			3.5			
$Q_{gd}$			4.8			
Gate Resistance	$R_g$	$f = 1\text{ MHz}$	1.2	5.7	11.5	$\Omega$
Turn-On Delay Time <sup>c</sup>	$t_{d(on)}$	$V_{DD} = -75\text{ V}$ , $R_L = 17.2\text{ }\Omega$ $I_D \cong -2.9\text{ A}$ , $V_{GEN} = -10\text{ V}$ , $R_g = 1\text{ }\Omega$		7	14	ns
Rise Time <sup>c</sup>	$t_r$			12	18	
Turn-Off Delay Time <sup>c</sup>	$t_{d(off)}$			33	50	
Fall Time <sup>c</sup>	$t_f$			9	18	
Drain-Source Body Diode Ratings and Characteristics $T_C = 25\text{ }^{\circ}\text{C}$ <sup>b</sup>						
Continuous Current	$I_S$				-10	A
Pulsed Current	$I_{SM}$				-30	
Forward Voltage <sup>a</sup>	$V_{SD}$	$I_F = -2.9\text{ A}$ , $V_{GS} = 0\text{ V}$		-0.8	-1.5	V
Reverse Recovery Time	$t_{rr}$	$I_F = -2.9\text{ A}$ , $dI/dt = 100\text{ A}/\mu\text{s}$		25	50	ns
Peak Reverse Recovery Current	$I_{RM(REC)}$			-4	-6	A
Reverse Recovery Charge	$Q_{rr}$			98	147	nC

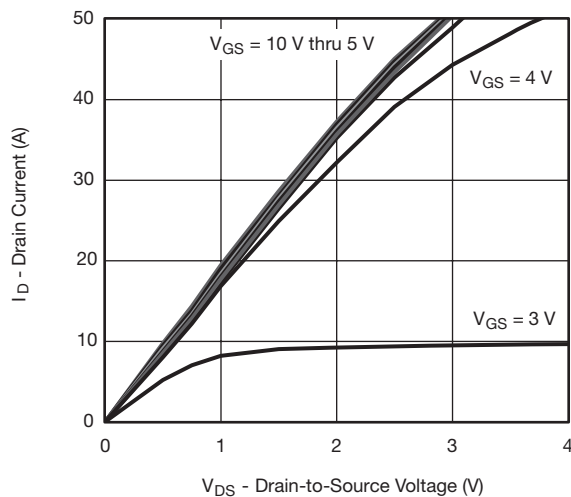
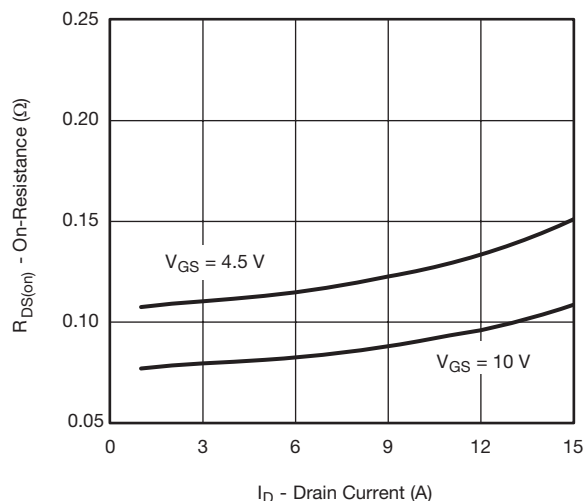
Notes:

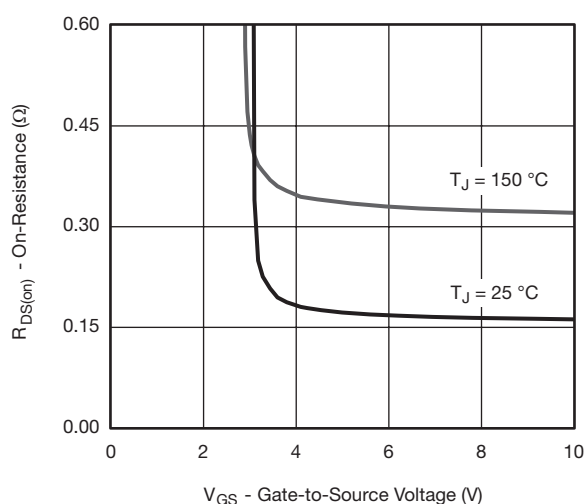
a. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$ .

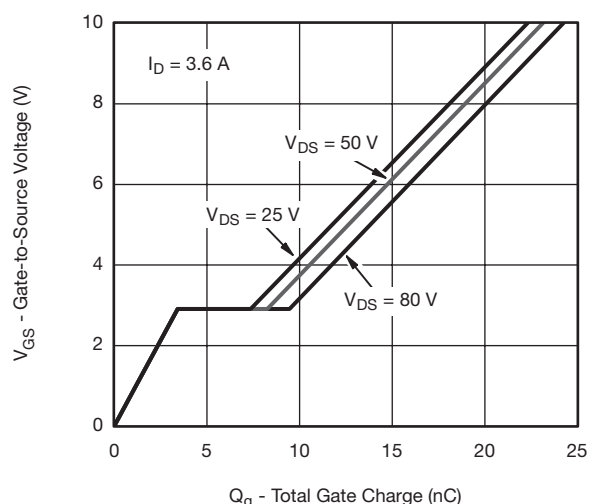
b. Guaranteed by design, not subject to production testing.

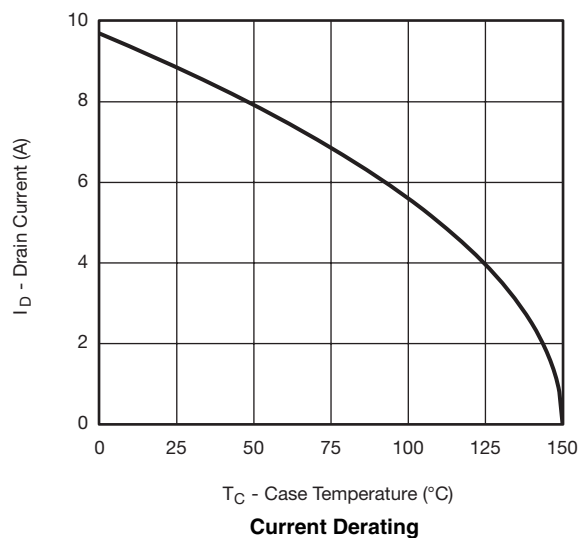
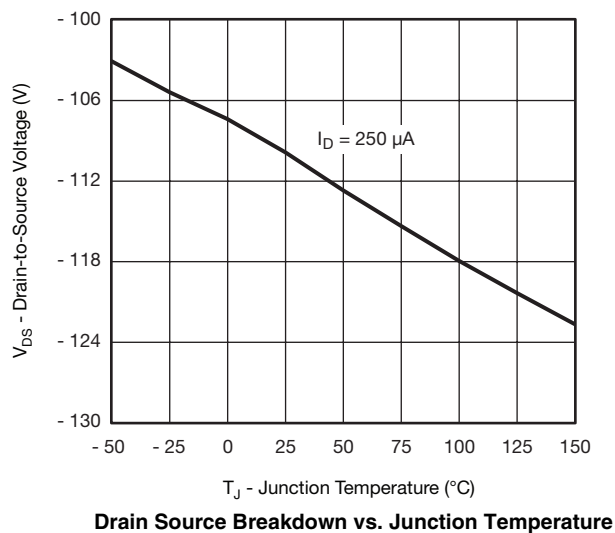
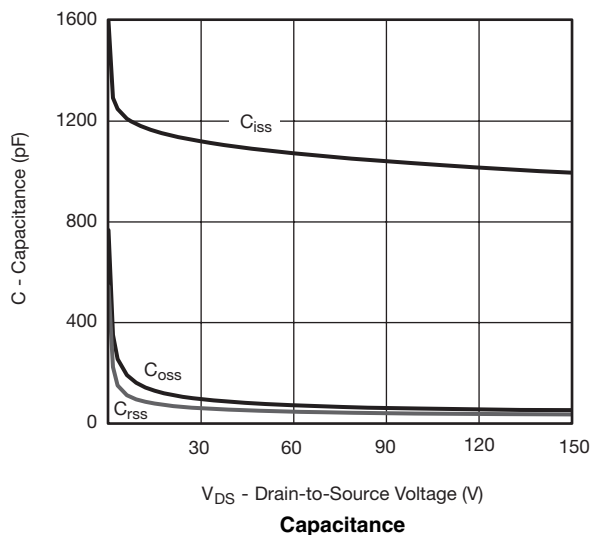
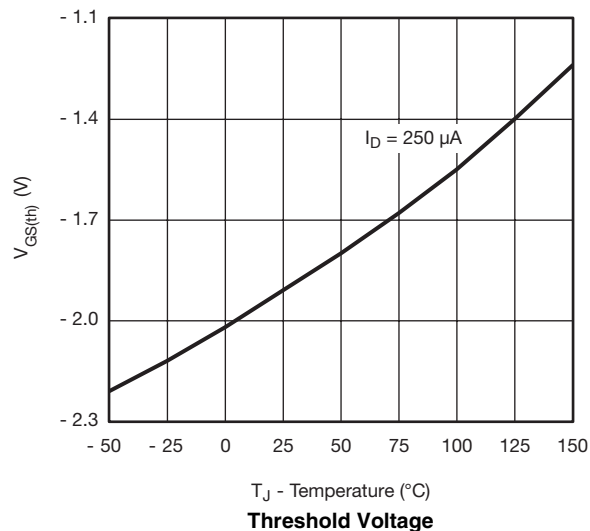
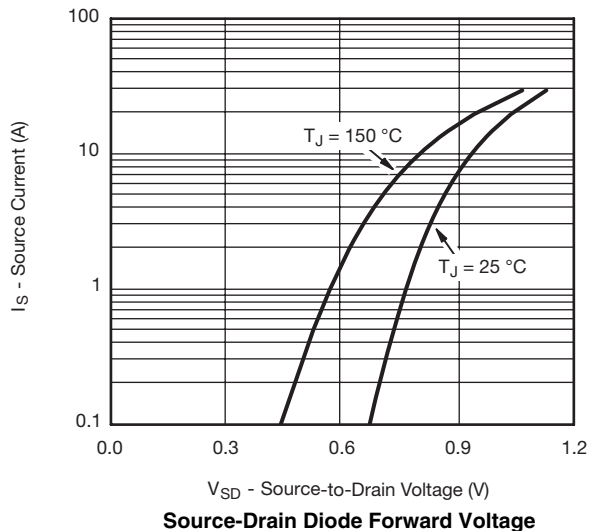
c. Independent of operating temperature.

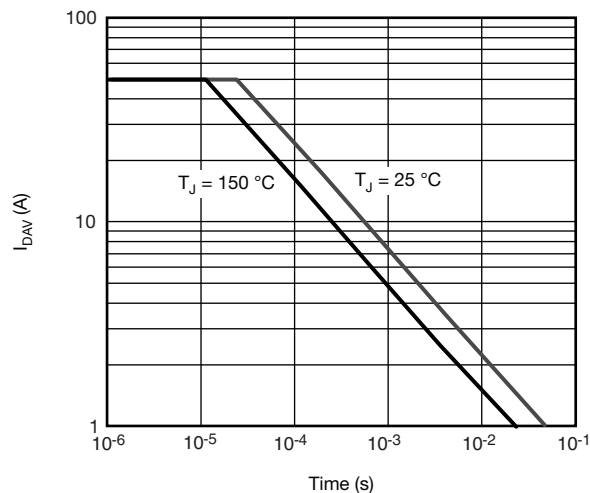
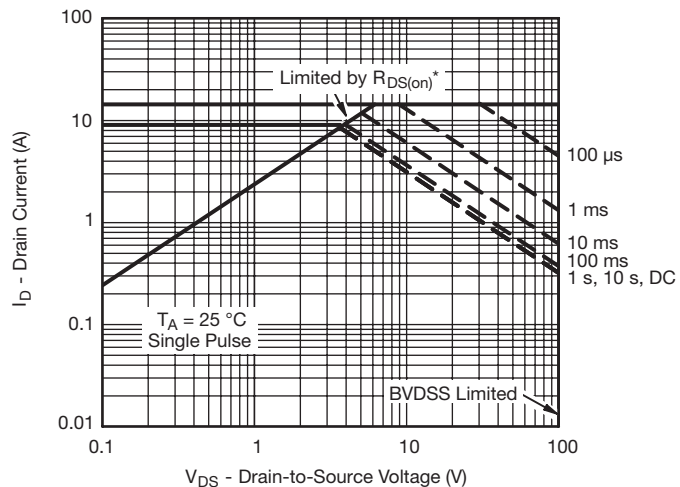
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted

**Output Characteristics**

**On-Resistance vs. Drain Current**

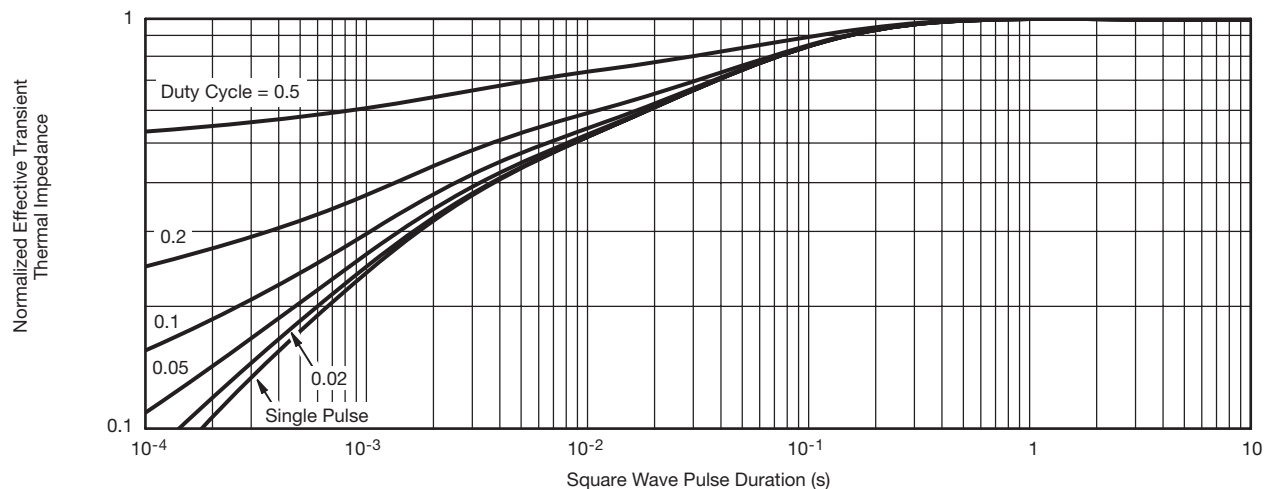
**Transfer Characteristics**

**On-Resistance vs. Gate-to-Source Voltage**

**Transconductance**

**Gate Charge**

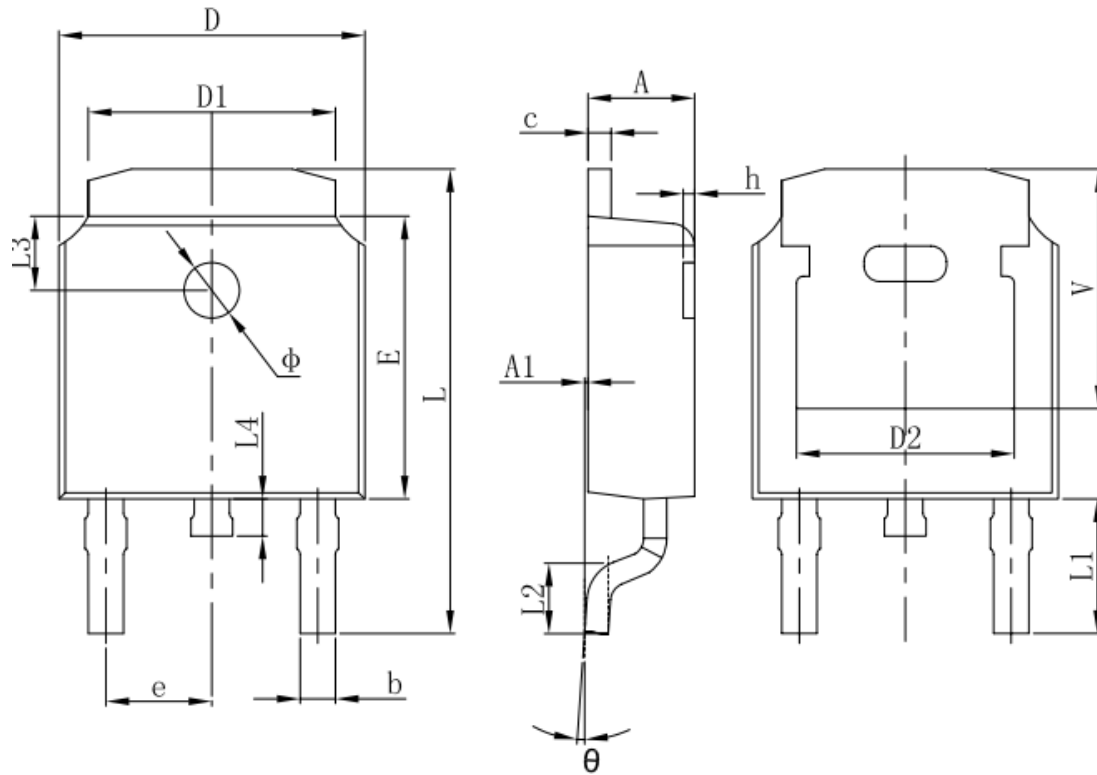
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**Single Pulse Avalanche Current Capability vs. Time**


\*  $V_{GS} >$  minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

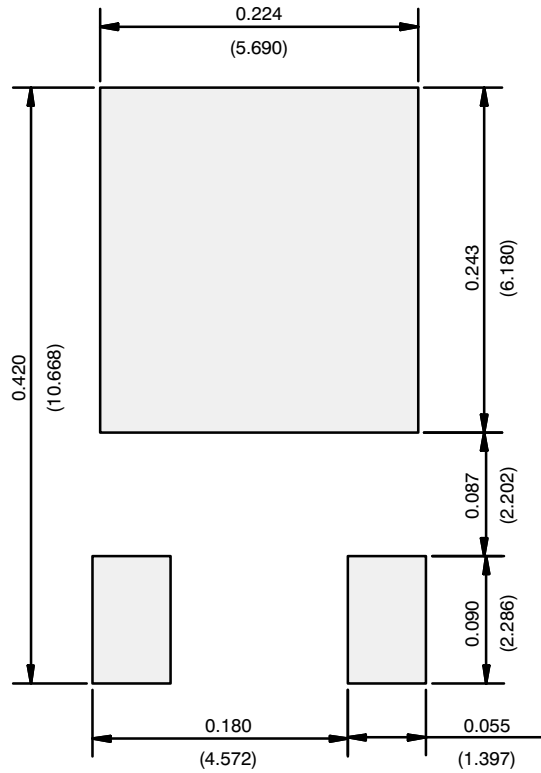
**Safe Operating Area**

**Normalized Thermal Transient Impedance, Junction-to-Case**

## TO252 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.635	0.770	0.025	0.030
c	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830 REF.		0.190 REF.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.712	10.312	0.382	0.406
L1	2.900 REF.		0.114 REF.	
L2	1.400	1.700	0.055	0.067
L3	1.600 REF.		0.063 REF.	
L4	0.600	1.000	0.024	0.039
Φ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.250 REF.		0.207 REF.	

## RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads  
Dimensions in Inches/(mm)

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